



www.jdsemi.cn

深圳市晶导电子有限公司  
ShenZhen Jingdao Electronic Co.,Ltd.

CM003N03C

Trench MOSFET

## 1、主要参数 Main Characteristics

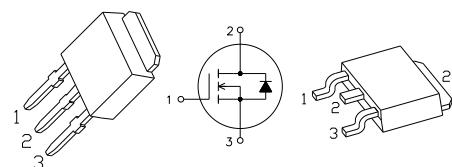
### 2、用途 Applications

- 负荷开关 Load Switch
- PWM 应用 PWM Application
- 电源管理 Power management

V <sub>DSS</sub>	30	V
I <sub>D</sub>	150	A
P <sub>D</sub>	108	W
R <sub>DSONTYP</sub>	16	mΩ

### 3、产品特性 Features

- 沟槽工艺 MOSFET Trench FET Power MOSFET
- 低栅极电荷 Low gate charge
- 低 Crss (典型值 431pF) Low Crss (typical 431pF)
- 通态电阻低 Low ON Resistance
- 产品全部经过雪崩测试 100% avalanche tested
- RoHS 产品 RoHS product



TO-251S TO-252S

1 栅极(G) 2 漏极 (D) 3 源极(S)

## 4. 电特性 Electrical Characteristics

### 4.1 极限值 Absolute Ratings (T<sub>c</sub> = 25°C)

参数名称 Parameter	符号 Symbol	额定值 Value	单位 Unit
漏极-源极电压 Drain-Source Voltage	V <sub>DSS</sub>	30	V
连续漏极电流 Drain Current -continuous	I <sub>D</sub>	T <sub>c</sub> = 25 °C	150
		T <sub>c</sub> = 100 °C	98
最大脉冲漏极电流 (注 1) Drain Current - pulse (note 1)	I <sub>DM</sub>	600	A
栅源电压 Gate-Source Voltage	V <sub>GS</sub>	±20	V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	E <sub>AS</sub>	225	mJ
耗散功率 Power Dissipation	P <sub>D</sub>	108	W
结温, 贮存温度 Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	150, -55~175	°C



www.jdsemi.cn

深圳市晶导电子有限公司

ShenZhen Jingdao Electronic Co.,Ltd.

CM003N03C

Trench MOSFET

4.2 电参数 Electrical Characteristics ( $T_C = 25^\circ\text{C}$ )

参数名称 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
<b>截止特性 Off -Characteristics</b>						
漏源击穿电压 Drain-Source Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	30			V
漏源击穿电压温度系数 Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$\text{I}_D = 250\mu\text{A}$		0.08		$^\circ\text{C}/\text{V}$
漏源漏电流 Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=30\text{V}, \text{V}_{\text{GS}}=0, 25^\circ\text{C}$		1		$\mu\text{A}$
		$\text{V}_{\text{DS}}=24\text{V}, \text{V}_{\text{GS}}=0, 125^\circ\text{C}$			10	
栅源漏电流 Gate-body leakage current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}= \pm 20\text{V}$			$\pm 100$	nA
<b>导通特性 On-Characteristics</b>						
静态导通电阻 (注 3) Static Drain-Source On-Resistance (note 3)	$\text{R}_{\text{DSON}}^*$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=30\text{A}$		16	20	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=20\text{A}$		18	22	
阈值电压 Gate Threshold Voltage	$\text{V}_{\text{GS (TH)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	1	1.6	2.5	V
跨导 Forward Transconductance	$\text{g}_{\text{fs}}$	$\text{V}_{\text{DS}}=15\text{V}, \text{I}_D=10\text{A}$		11		S
脉冲宽度 $\text{tp} \leq 380\mu\text{s}$ , 占空比 $\delta \leq 2\%$						
<b>动态特性 Dynamic Characteristics</b>						
输入电容 Input capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=15\text{V}$ $f=1.0\text{MHz}$		3500		$\text{pF}$
输出电容 Output capacitance	$\text{C}_{\text{oss}}$			500		
反向传输电容 Reverse transfer capacitance	$\text{C}_{\text{rss}}$			431		
<b>开关特性 Switching Characteristics</b>						
开启延迟(时间) Turn-On delay time	$t_{\text{d(ON)}}$	$\text{I}_D = 30\text{A}$ $\text{V}_{\text{DD}} = 15\text{V}$ $\text{V}_{\text{GS}} = 10\text{V}$ $\text{R}_{\text{GEN}} = 3\Omega$		26		$\text{nS}$
上升时间 Turn-On rise time	$t_r$			24		
关断延迟(时间) Turn-Off delay time	$t_{\text{d(OFF)}}$			91		
下降时间 Turn-Off Fall time	$t_f$			39		
栅极电荷 Total Gate Charge	$\text{Q}_g$	$\text{I}_D=30\text{A}, \text{V}_{\text{DS}}=15\text{V}$ $\text{V}_{\text{GS}}=10\text{V}$		38		$\text{nC}$
栅源电荷 Gate-Source charge	$\text{Q}_{\text{gs}}$			9		
栅漏电荷 Gate-Drain charge	$\text{Q}_{\text{gd}}$			13		

地址：深圳市宝安区石岩街道洲石路中集创谷产业园 B 栋 1-3 层 电话：0755-29799516 传真：0755-29799515



www.jdsemi.cn

深圳市晶导电子有限公司

ShenZhen Jingdao Electronic Co.,Ltd.

CM003N03C

Trench MOSFET

源-漏二极管特性 Drain-Source Diode Characteristics						
源漏二极管连续电流 Maximum Continuous Drain -Source Diode Forward Current	I <sub>SD</sub>	T <sub>c</sub> = 25 °C			150	A
源漏二极管脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current	I <sub>SDM</sub>				600	A
源漏二极管正向压降 Drain-Source Diode Forward Voltage	V <sub>FSD</sub>	I <sub>SD</sub> =30A, V <sub>GS</sub> =0			1.5	V
反向恢复时间 Reverse recovery time	t <sub>rr</sub>	I <sub>SD</sub> =20A, T <sub>j</sub> = 25 °C dI <sub>F</sub> /dt=100A/us, V <sub>GS</sub> =0V		42		nS
反向恢复电荷 Reverse recovery charge	Q <sub>rr</sub>			39		nC

参数名称 Parameter	符号 Symbol	额定值 Value	单位 Unit
热阻（结到壳） Thermal Resistance, Junction to Case	R <sub>θJC</sub>	1.56	°C/W
热阻（结到环境） Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	62.5	°C/W

注:

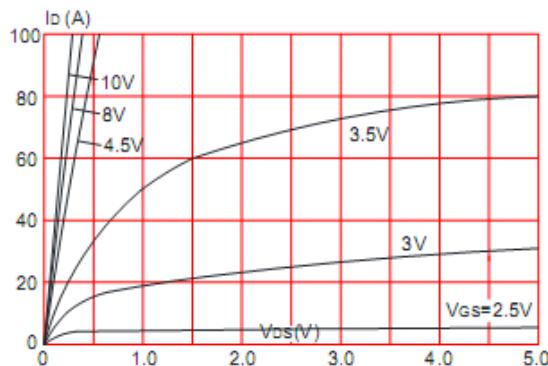
- 1 重复脉冲, 宽度由最高结温限制  
 2 L=0.5mH, I<sub>D</sub>=30 A, 起始结温 T<sub>j</sub>=25 °C  
 3 脉冲测试: 脉冲宽度≤300 μ s, 占空比≤0.5%

Notes:

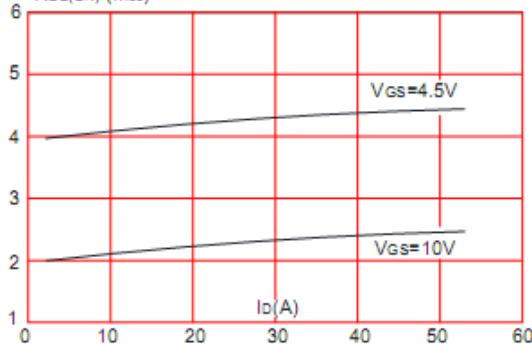
- 1 Pulse width limited by maximum junction temperature  
 2 L=0.5mH, I<sub>D</sub>=30A, Starting T<sub>j</sub>=25 °C  
 3 Pulse Test: Pulse Width≤300 μ s, Duty Cycle≤0.5%

## 5. 特性曲线 Characteristics Curve

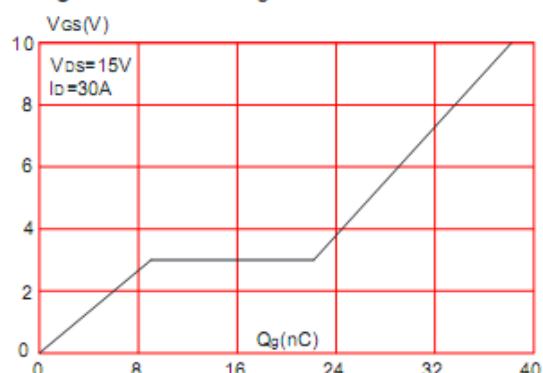
**Figure1: Output Characteristics**



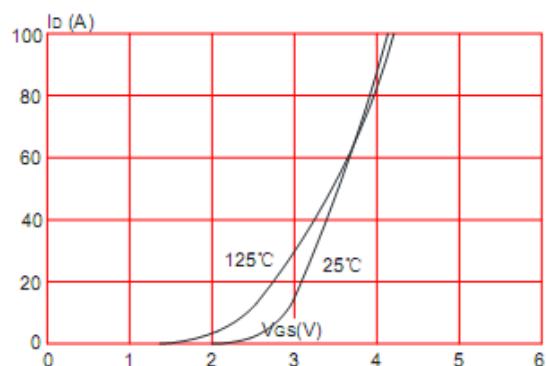
**Figure 3: On-resistance vs. Drain Current**



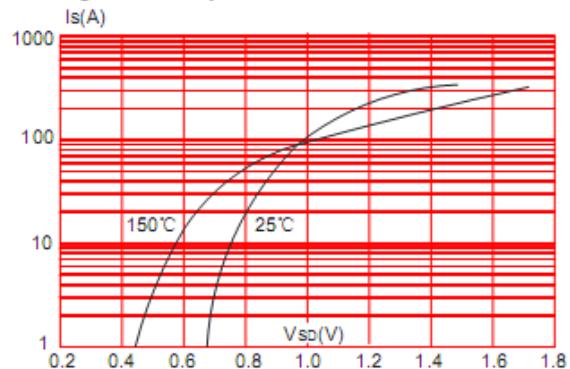
**Figure 5: Gate Charge Characteristics**



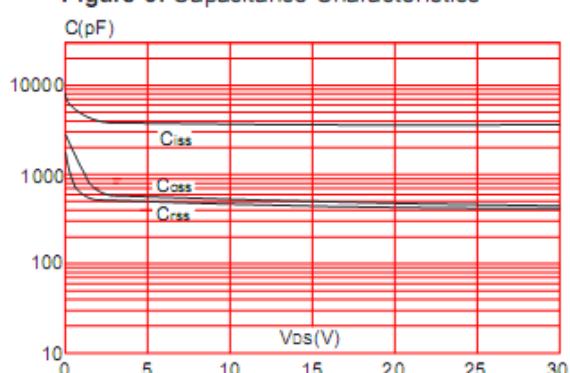
**Figure 2: Typical Transfer Characteristics**



**Figure 4: Body Diode Characteristics**



**Figure 6: Capacitance Characteristics**





www.jdsemi.cn

深圳市晶导电子有限公司  
ShenZhen Jingdao Electronic Co.,Ltd.

CM003N03C

Trench MOSFET

Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

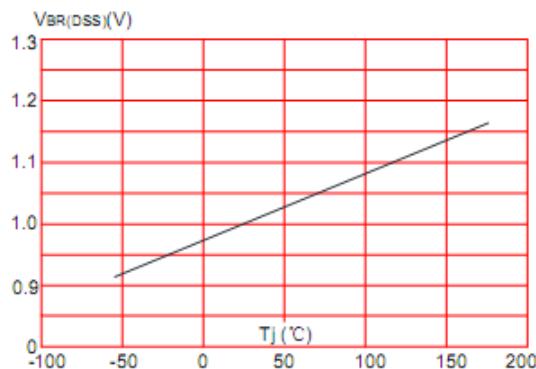


Figure 8: Normalized on Resistance vs. Junction Temperature

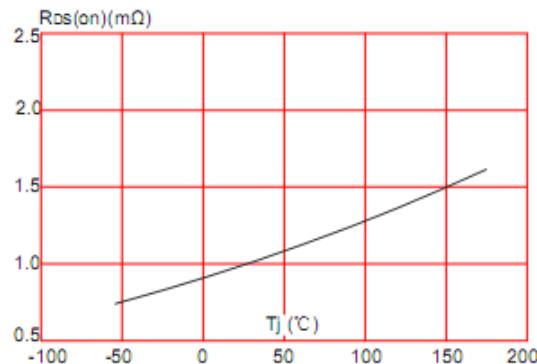


Figure 9: Maximum Safe Operating Area

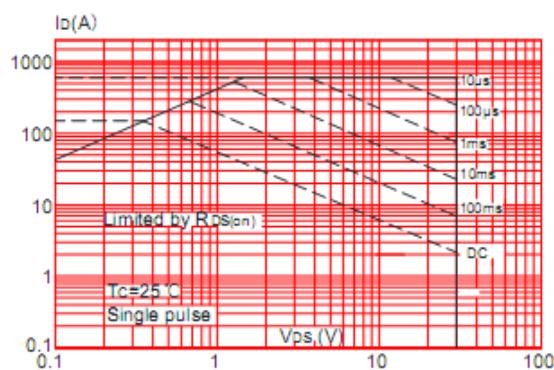


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

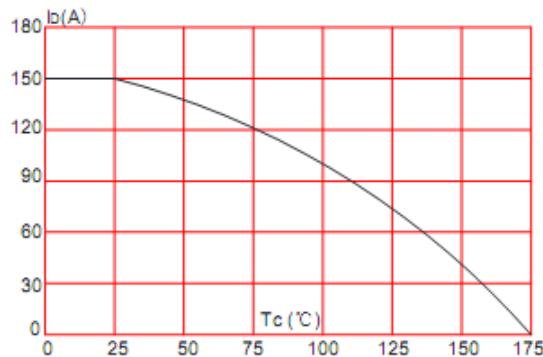
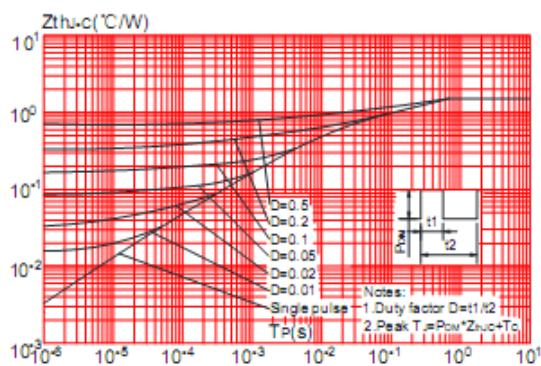


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case





www.jdsemi.cn

深圳市晶导电子有限公司

ShenZhen Jingdao Electronic Co.,Ltd.

CM003N03C

Trench MOSFET

## 6. 测试电路 Test Circuit

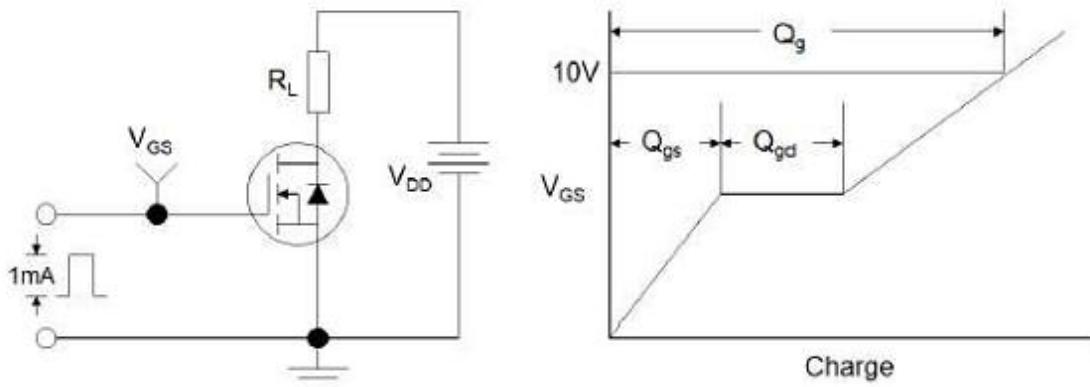


Figure1:Gate Charge Test Circuit & Waveform

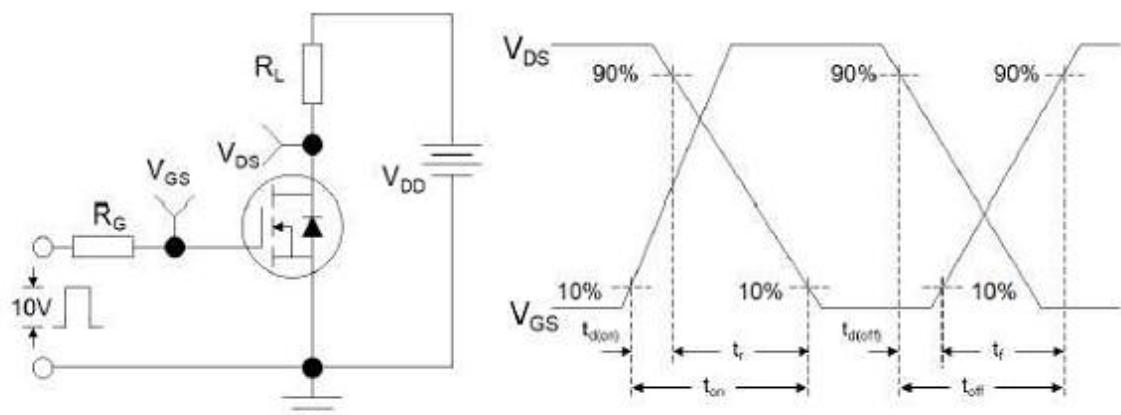


Figure 2: Resistive Switching Test Circuit & Waveforms

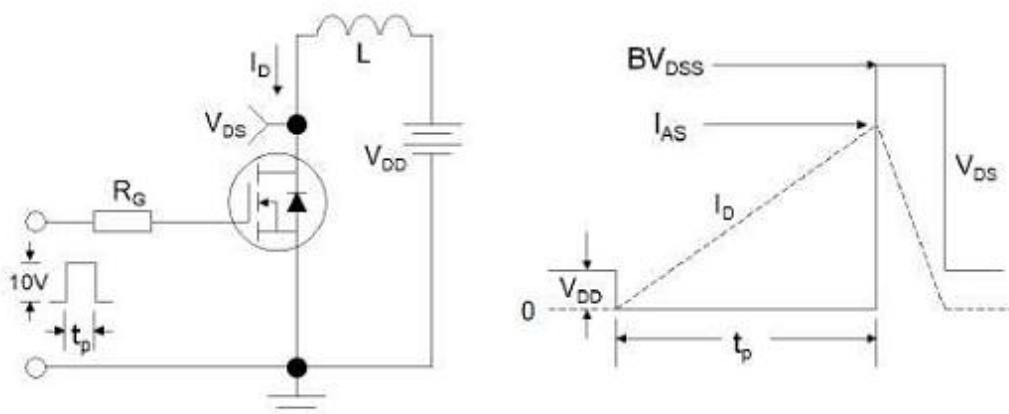


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

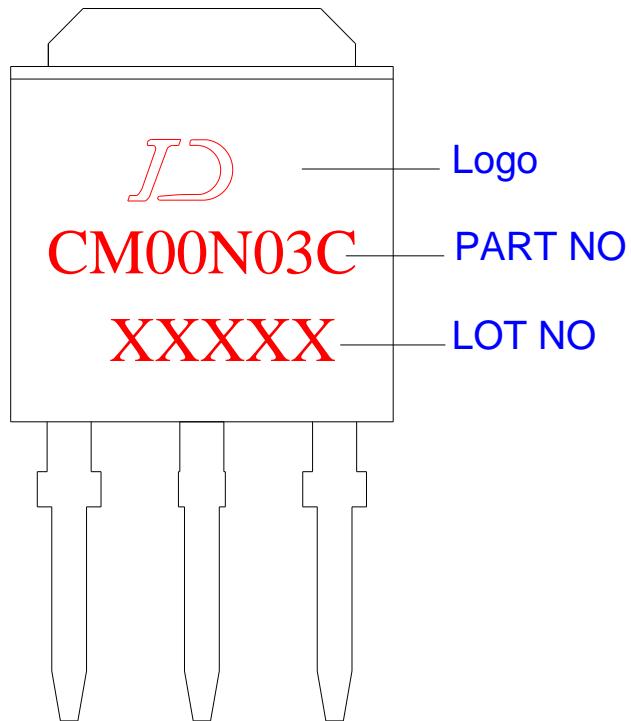


www.jdsemi.cn

深圳市晶导电子有限公司  
ShenZhen Jingdao Electronic Co.,Ltd.

CM003N03C  
*Trench MOSFET*

## 7. Marking (印章说明)





www.jdsemi.cn

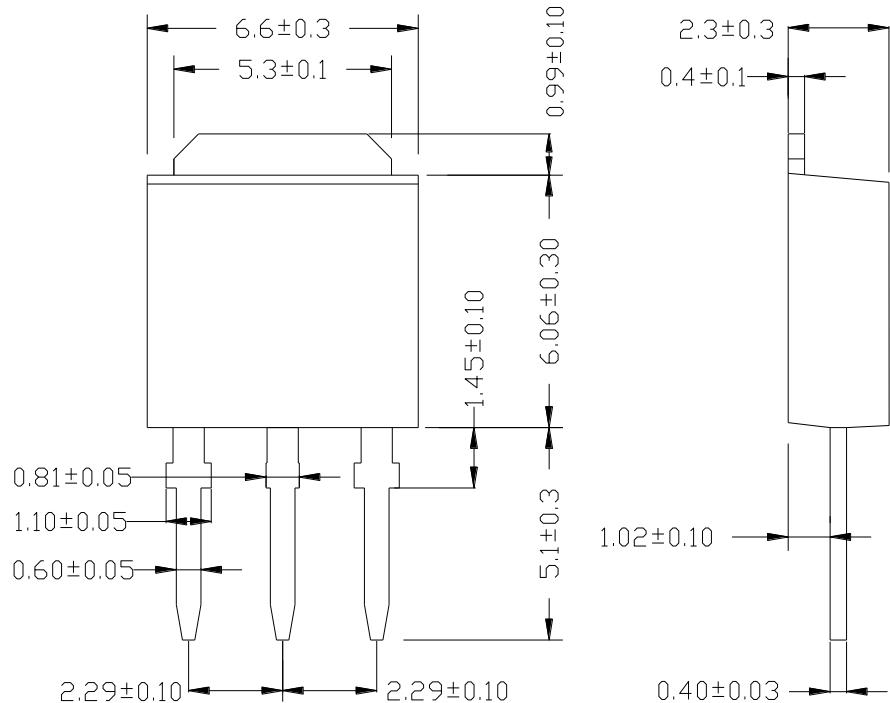
深圳市晶导电子有限公司  
ShenZhen Jingdao Electronic Co.,Ltd.

CM003N03C

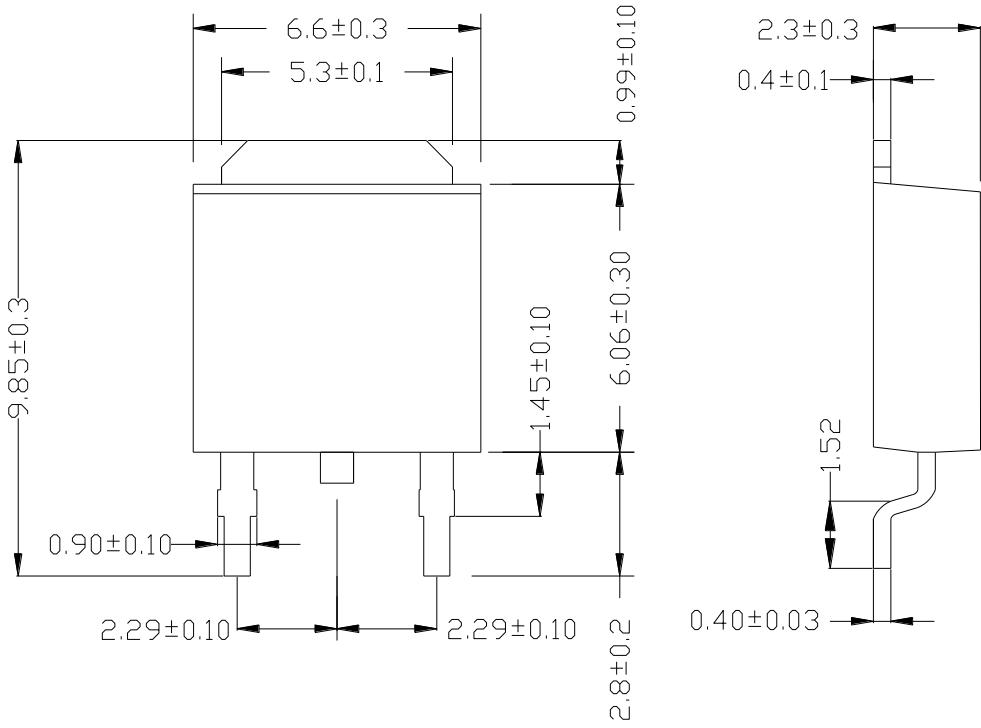
Trench MOSFET

## 8. 产品外形尺寸图(单位: mm) Package Dimensions(Unit: mm)

T0-251S



T0-252S





www.jdsemi.cn

深圳市晶导电子有限公司

ShenZhen Jingdao Electronic Co.,Ltd.

CM003N03C

Trench MOSFET

**The name and content of poisonous and harmful material in products**

Part's Name	Hazardous Substance					
	Pb	Hg	Cd	Cr(VI)	PBB	PBDE
Limit	≤0.1%	≤0.1%	≤0.01%	≤0.1%	≤0.1%	≤0.1%
Lead Frame	○	○	○	○	○	○
Molding Compound	○	○	○	○	○	○
Chip	○	○	○	○	○	○
Wire Bonding	○	○	○	○	○	○
Solder	×	○	○	○	○	○
Note	<p>○: means the hazardous material is under the criterion of SJ/T11363-2006. ×: means the hazardous material exceeds the criterion of SJ/T11363-2006. The plumbum element of solder exist in products presently, but within the allowed range of Eurogroup's RoHS.</p>					

**Warnings**

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximum ratings of the device.
2. When installing the heatsink, please pay attention to the torsional moment and the smoothness of the heatsink.
3. VDMOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. This publication is made by Jingdao Electronic and subject to regular change without notice.